



2813  
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Yamazaki, et al.      Art Unit : 2813  
Serial No.: 09/451,665      Examiner : Laura Schillinger  
Filed : November 30, 1999  
Title : SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD  
THEREOF

Commissioner for Patents  
Washington, D.C. 20231

TRANSMITTAL LETTER

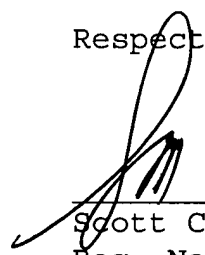
Correspondence relating to this application is enclosed.  
The required fees are computed below. Please apply any charges  
not covered, or any credits, to Deposit Account No. 06-1050.

Total Claims	82	-	56	=	26	\$468
Independent	10	-	8	=	2	\$160
TOTAL FEE DUE						\$628

A check for \$628 is attached.

Respectfully submitted,

Date: 8/8/01

  
\_\_\_\_\_  
Scott C. Harris  
Reg. No. 32,030

Fish & Richardson P.C.  
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\_\_\_\_\_  
Susan Regan  
Typed or Printed Name of Person Signing Certificate



Attorney's Docket No.: 07977/017002/US2968C1D1

#9/Amend C  
a total  
8/21/01

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Washington, D.C. 20231

AMENDMENT

Sir:

In response to the Official Action dated May 9, 2001, Paper No. 8, in the above-referenced application, please amend the above-identified application as follows.

In the Claims:

Please amend the claims as follows.

RECEIVED  
AUG 20 2001  
TECHNOLOGY CENTER 2800

SUB  
DI  
C1  
1. (Amended) A method of manufacturing a semiconductor device comprising the steps of:  
forming a crystalline semiconductor film on an insulating surface;

03/17/2001 MWOLDER1 00000071 09451665

01 FC:102 160.00 OP  
02 FC:103 460.00 OP

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

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*Susan Regan*

Susan Regan

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